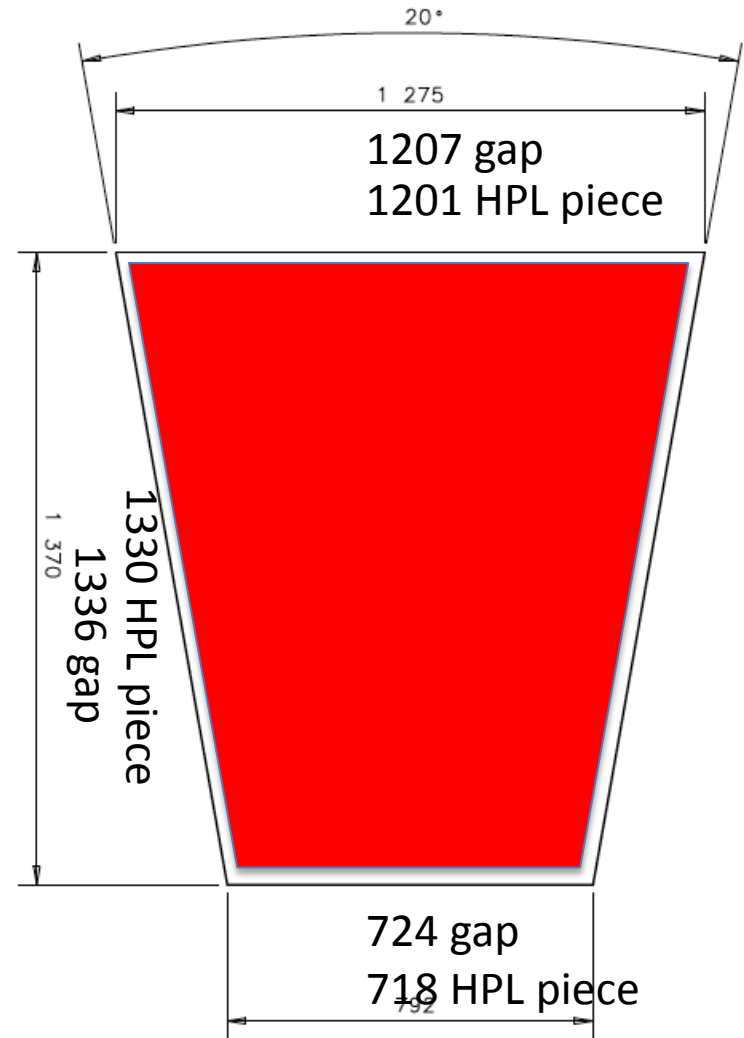


Chamber structure proposal

- Use the SAME gap size for Top & Bottom
- Simplify the strip exit on both sides for 2 partitions
(to be confirmed by physics requirements)
- Strip plate compatible with PCB option
- Amount of strips compatible with 1 LB/chamber= 96 ch
- FEBs compatible with RE options
- Position of FEBs driven by cable length optimisation
- FEB Cooling and Chamber Thermalisation in pipeline with present RE3 and RE4 services
- Same concept for trapezoidal or rectangular prototypes

Trapezoid: Gap size -> HPL piece size

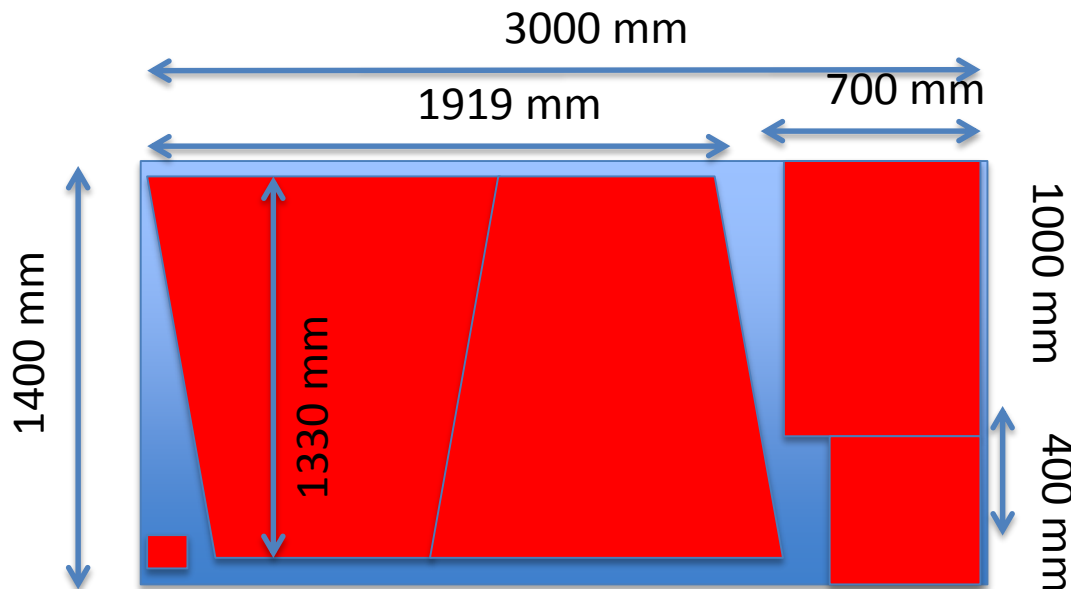
- Assuming gap size 3 mm smaller on each side
- AGAIN: Watch this is BOTTOM gap only



Trapezoid: Panel cut

- 2 trapezoid pieces + 1 rectangular big + 1 rectangular small + 1 small piece for glue tests :
1 panel = 3 gaps
- In rectangular pieces ALL 4 Corners cut as usual 4cm diagonal

Useful panel size 3000x1400 mm²



For KODEL:

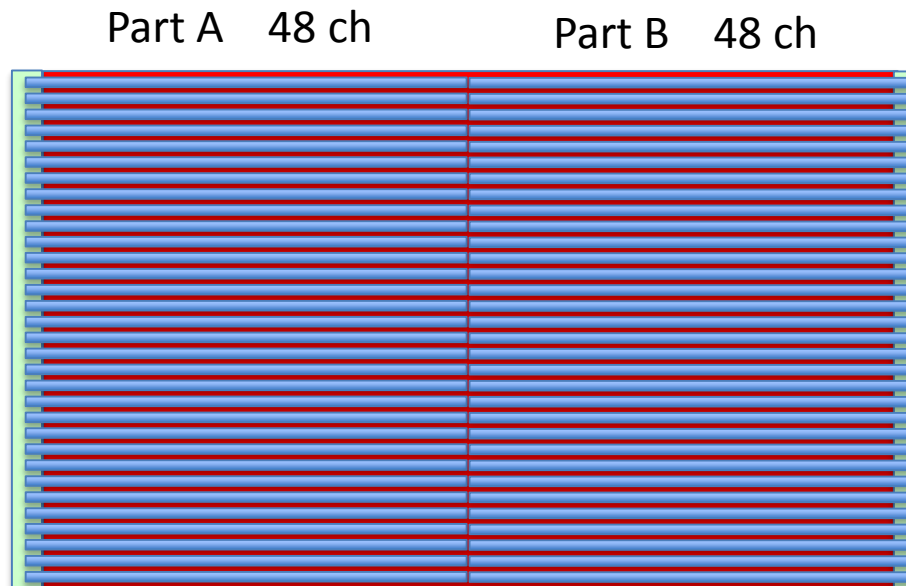
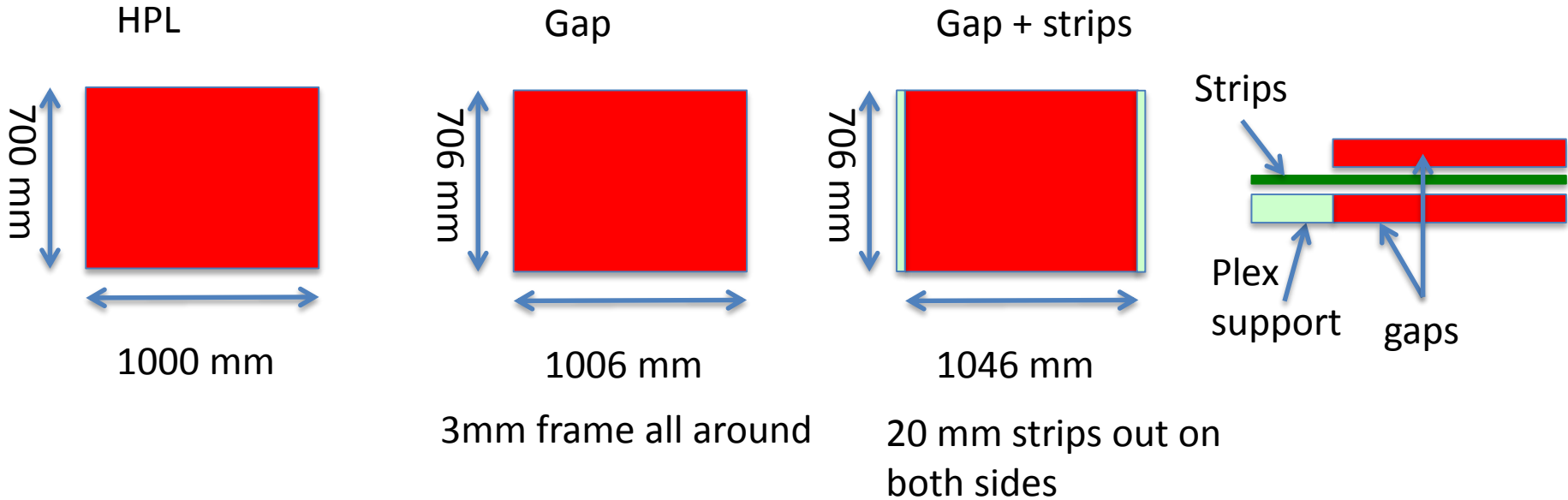
3 panels 1,6 mm:

#	resistivity
13	2,4
14	2,7
15	2,7

3 panels 2,0 mm

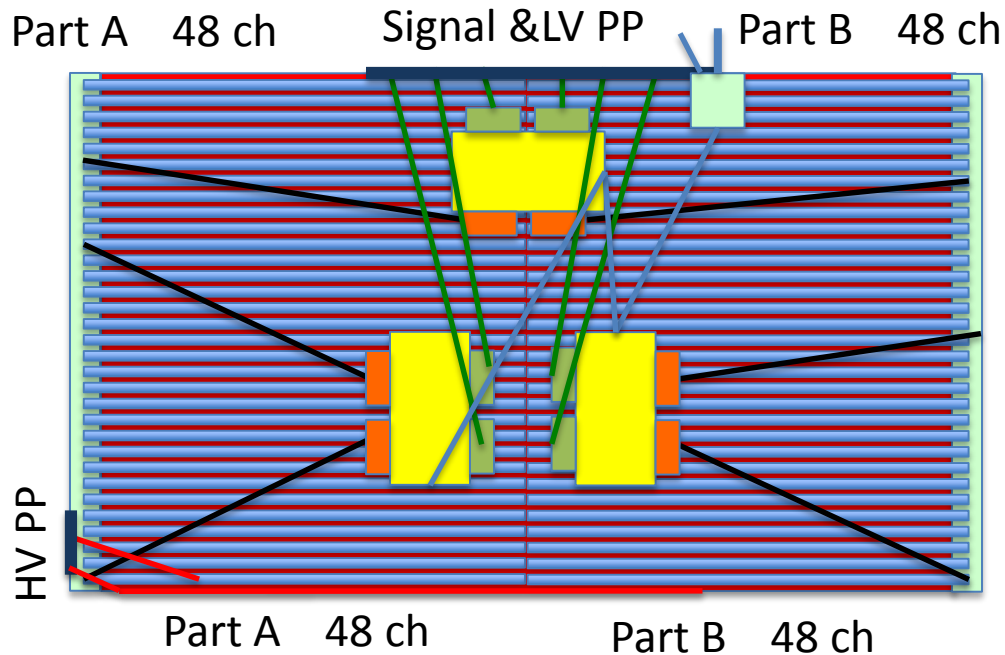
#	resistivity
48	4,3
49	4,1
50	4,0

Chamber Strips



In case of PCB for strips, we could also position connectors and FEBs directly on PCB

Chamber: FEB position & cabling



1.5 FEB / partition

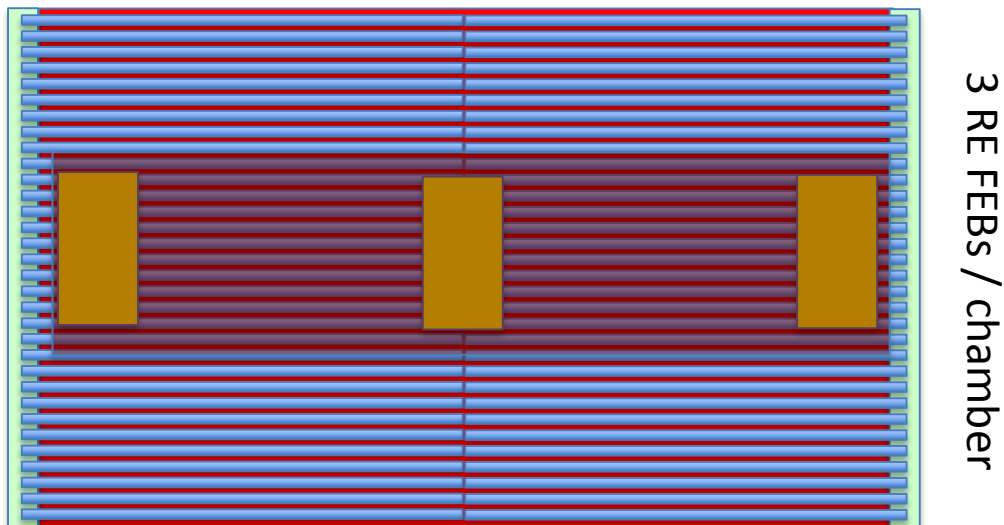
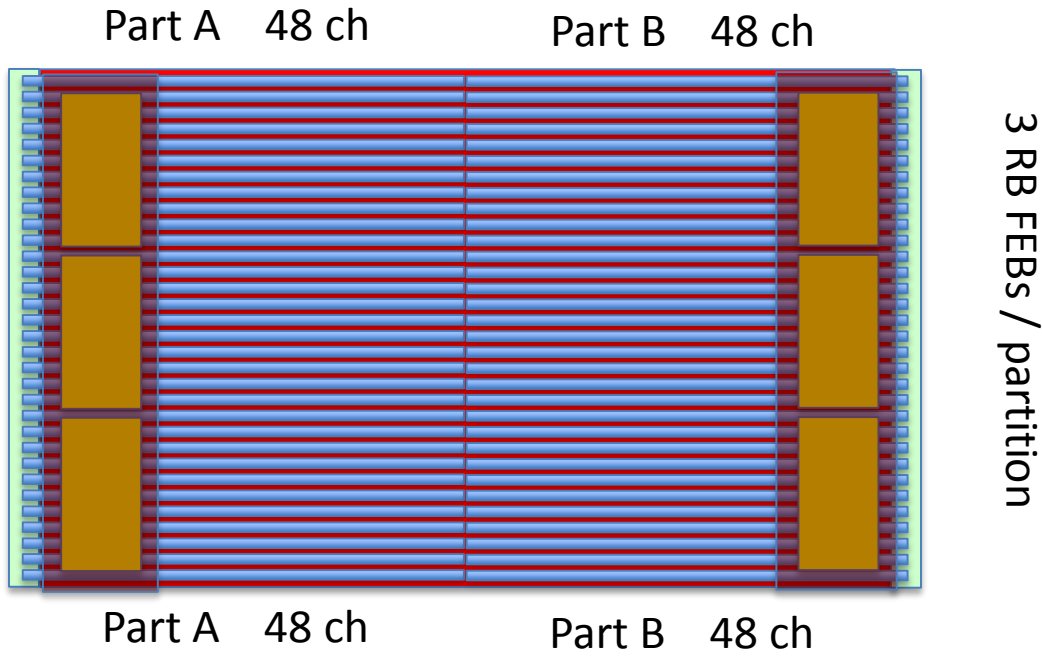
FEBs in central position for same cable length

- LV Distribution Board (DB)
- Adaptor Board (AB)
- FEB Connector (FC)

For 3 chambers we will need:

- 4 LV DB (3+1 spare)
- 10 FEBs (9+1)
- 20 AB (18+2)
- 20 signal cables 18+2)
- 40 signal connectors (36+4)
- 15 LVDB connectors (12+3)
- LVDB flat cables 5m (4+1)

Chamber: Cooling



Entire Chamber thermalised

3 RE FEBS / chamber

